

Praetorian® 8-Channel EMI Filter Array with ESD Protection

CM1453-08CP

Features

- · Eight channels of EMI filtering
- ±15kV ESD protection
- (IEC 61000-4-2, contact discharge)
- ±30kV ESD protection (HBM)
- Greater than -40dB of attenuation at 1GHz
- Chip Scale Package (CSP) with 0.40mm pitch and 0.25mm CSP solder ball which features extremely low parasitic inductance for optimum filter and ESD performance
- OptiGuard[™] Coating for improved reliability at assembly
- RoHS compliant

Applications

- LCD and Camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules

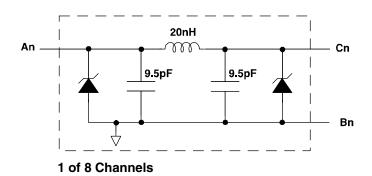
Product Description

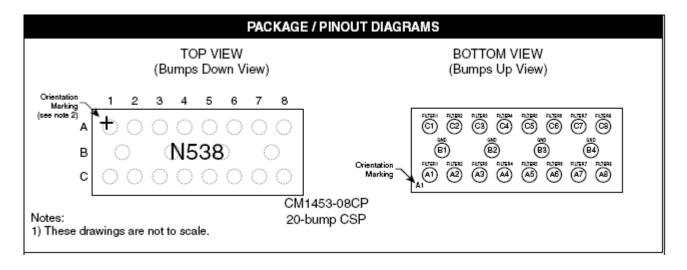
The CM1453-08CP is a pi-style EMI filter array with ESD protection, which integrates eight filters (C-L-C) in CSP form factor with 0.40mm pitch. Each EMI filter channel of the CM1453-08CP is implemented as a 3-pole L-C filter where the component values are 9.5pF-20nH-9.5pF. The roll-off frequency at -6dB attenuation is 380MHz and can be used in applications where the data rates are as high as 160Mbps while providing greater than -35dB over the 800MHz to 2.7GHz frequency range. The parts include ESD diodes on every I/O pin and provide a high level of protection against electrostatic discharge (ESD). The ESD protection diodes connected to the filter ports are designed and characterized to safely dissipate ESD strikes of ±15kV, beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30kV.

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1453-08CP is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

The CM1453-08CP incorporates *OptiGuard*[™] which results in improved reliability at assembly. It is manufactured with a 0.40mm pitch and 0.25mm CSP solder ball to provide up to 28% board space savings vs. competing CSP devices with 0.50mm pitch and 0.30mm CSP solder ball.

Electrical Schematic





PIN DESCRIPTIONS					
PIN NUMBER	PIN	PIN PIN NUMBER			
-08	DESCRIPTION	-08	DESCRIPTION		
A1	Filter #1	C1	Filter #1		
A2	Filter #2	C2	Filter #2		
A3	Filter #3	C3	Filter #3		
A4	Filter #4	C4	Filter #4		
A5	Filter #5	C5	Filter #5		
A6	Filter #6	C6	Filter #6		
A7	Filter #7	C7	Filter #7		
A8	Filter #8	C8	Filter #8		
B1	GND	-			
B2	GND	-			
B3	GND	-			
B4	GND	-			

Ordering Information

PART NUMBERING INFORMATION				
		Lead-free Finish		
Bumps	Package	Ordering Part Number ¹	Part Marking	
20	CSP	CM1453-08CP	N538	

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

CM1453-08CP

Specifications

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	RATING	UNITS			
Storage Temperature Range	-65 to +150	°C			
DC current per Inductor	30	mA			
DC Package Power Rating	0.5	W			

STANDARD OPERATING CONDITIONS					
PARAMETER	RATING	UNITS			
Operating Temperature Range	-40 to +85	°C			

ELECTRICAL OPERATING CHARACTERISTICS (NOTE 1) **SYMBOL** UNITS **PARAMETER CONDITIONS** MIN **TYP** MAX Total Channel Inductance 20 nΗ L_{TOT} Total Channel Capacitance (C, x 2) \mathbf{C}_{tot} 2.5V dc; 1MHz, 30mV ac 15.2 19 22.8 рF 2.5V dc; 1MHz, 30mV ac 9.5 рF C, Capacitance $V_{\rm ST}$ Stand-off Voltage $I = 10\mu A$ 5.5 ٧ $\mu \textbf{A}$ Diode Leakage Current 0.1 1.0 LEAK $V_{IN} = 3.3V$ V_{SIG} Signal Clamp Voltage Positive Clamp ٧ $I_{\scriptscriptstyle LOAD} = 10 mA$ 5.6 6.8 9.0 **Negative Clamp** $I_{LOAD} = -10 \text{mA}$ -1.5 -0.8 -0.4 $\boldsymbol{V}_{\text{ESD}}$ In-system ESD Withstand Voltage Notes 2 and 3 a) Human Body Model, MIL-STD-883, Method 3015 kV ± 30 b) Contact Discharge per IEC 61000-4-2 Level 4 kV ±15 f_c Cut-off frequency 300 MHz $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$ Roll-off frequency at -6dB Attenuation 380 MHz f_{c} $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$ Dynamic Resistance R_{DYN} Positive 2.3 Ω Negative 0.9

Note 1: $T_A=25$ °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Unused pins are left open.

Performance Information

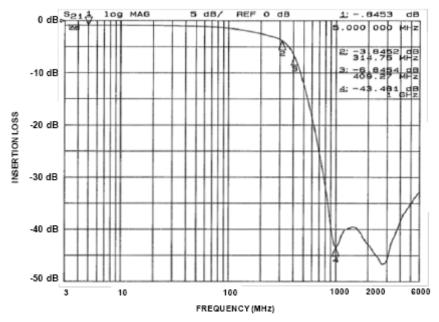


Figure 1. Insertion Loss VS. Frequency (CM1453-08: Filter 1)

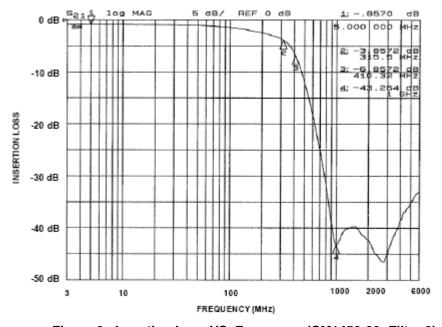


Figure 2. Insertion Loss VS. Frequency (CM1453-08: Filter 2)

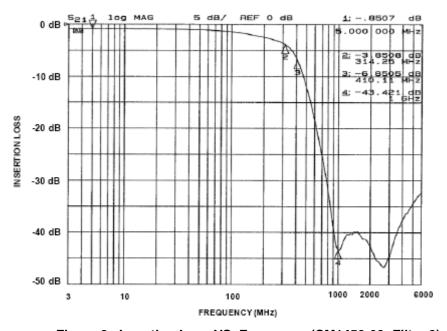


Figure 3. Insertion Loss VS. Frequency (CM1453-08: Filter 3)

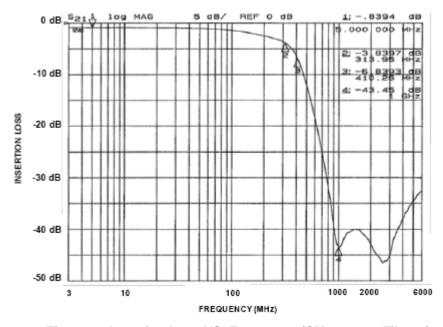


Figure 4. Insertion Loss VS. Frequency (CM1453-08: Filter 4)

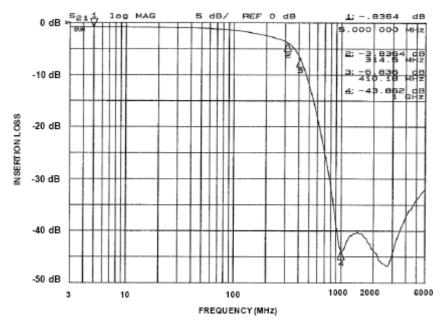


Figure 5. Insertion Loss VS. Frequency (CM1453-08: Filter 5)

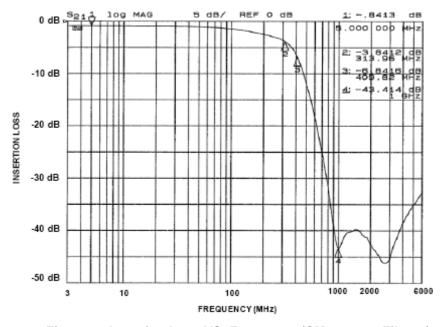


Figure 6. Insertion Loss VS. Frequency (CM1453-08: Filter 6)

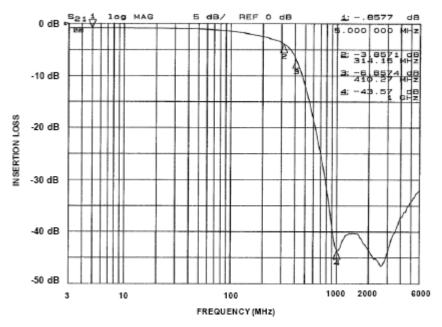


Figure 7. Insertion Loss VS. Frequency (CM1453-08: Filter 7)

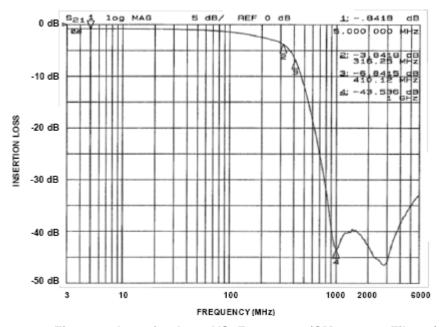


Figure 8. Insertion Loss VS. Frequency (CM1453-08: Filter 8)

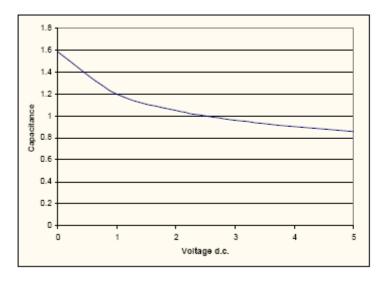


Figure 9. Typical Diode Capacitance vs. Input Voltage (normalized to 2.5V d.c)

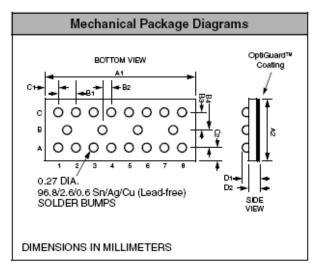
Application Information

Refer to Application Note AP-217, "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by California Micro Devices. See http://www.wlcspforum.org/documents/pdf/ap-217.pdf for download.

Mechanical Specifications

CM1453 devices are packaged in custom Chip Scale Packages (CSP). See Application Note AP-217 for more information at: http://www.wlcspforum.org/documents/pdf/ap-217.pdf.

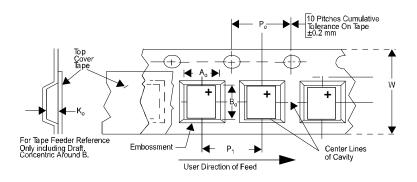
PACKAGE DIMENSIONS							
Pack	age	Custom CSP					
Bumps		20					
Dim	M	/lillimeters					
	Min	Nom	Max	Min	Nom	Max	
A 1	3.229	3.274	3.319	0.1271	0.1289	0.1307	
A2	1.099	1.144	1.189	0.0433	0.0450	0.0468	
B1	0.395	0.400	0.405	0.0156	0.0157	0.0159	
B2	0.195	0.200	0.205	0.0077	0.0079	0.0081	
В3	0.342	0.347	0.352	0.0135	0.0137	0.0139	
B4	0.342	0.347	0.352	0.0135 0.0137		0.0139	
C1	0.187	0.237	0.287	0.0074	0.0093	0.0113	
C2	0.175	0.225	0.275	0.0069	0.0089	0.0108	
D1	0.545	0.615	0.685	0.0215	0.0242	0.0270	
D2	0.368	0.419	0.470	0.0145	0.0165	0.0185	
# per tape and reel		3500 pieces					
Controlling dimension: millimeters							



Package Dimensions for CM1453-08CP Chip Scale Package

CSP Tape and Reel Specifications

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B _o X A _o X K _o	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P _o	P ₁
CM1453-08CP	3.27 X 1.14X 0.615	3.40 X 1.27 X 0.73	12mm	330mm (13")	3500	4mm	4mm



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